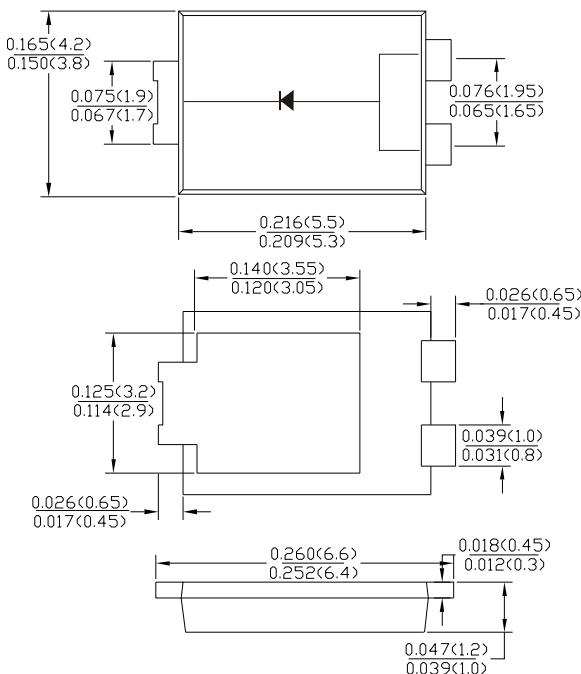


Features

- Schottky Barrier Chip
- High Thermal Reliability
- Patented Super Barrier Rectifier Technology
- High Forward Surge Capability
- Ultra Low Power Loss, High Efficiency
- Excellent High Temperature Stability
- Plastic material-UL flammability 94V-0

TO-277



Mechanical Data

- Case: TO-277, molded plastic
- Terminals: Plated Leads Solderable per MIL-STD-202, Method 208
- Polarity: Cathode Band
- Mounting Position: Any
- Marking: Type Number
- Lead Free: For RoHS/Lead Free Version

Dimensions inches and (millimeters)

Maximum Ratings and Electrical Characteristics @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Single Phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Parameter	Symbol	SR 1045L	SR 1050L	SR 1060L	SR 1080L	SR 10100L	SR 10150L	Unit
Peak Repetitive Reverse Voltage	V_{RRM}							
Working Peak Reverse Voltage	V_{RWM}	45	50	60	80	100	150	V
DC blocking voltage	V_{DC}							
RMS Rectified Voltage	$V_{R(RMS)}$	28	35	42	56	70	105	V
Average Rectified Output Current (Note1)	I_O					10		A
Non-Repetitive Peak Forward Surge 8.3ms								
Single Half Sine-Wave Superimposed on rated load(JEDEC Method) (Note2)	I_{FSM}					275		A
Forward Voltage Drop $T_A = 25^\circ\text{C}$ @ $I_F = 10\text{A}$	V_{FM}	0.42	0.45	0.47	0.75		0.78	V
Peak Reverse Current $T_A = 25^\circ\text{C}$ At Rated DC Blocking Voltage $T_A = 100^\circ\text{C}$	I_R				0.3		15	mA
Typical Thermal Resistance Junction to Ambient	$R_{\theta JA}$				80			$^\circ\text{C}/\text{W}$
	$R_{\theta JL}$				15			
Operating junction temperature range	T_J				-55 to +150			$^\circ\text{C}$
Storage temperature range	T_{STG}				-55 to +150			$^\circ\text{C}$

Note: 1. Valid Provided that are kept at ambient temperature at a distance of 9.5mm from the case.

2. Fr-4pcb.2oz.Copper, minimum recommend pad layout .18.8mm×14.4mm. Anode pad dimensions 5.6mm×14.4mm.

Fig.1 - Forward Current Derating Curve

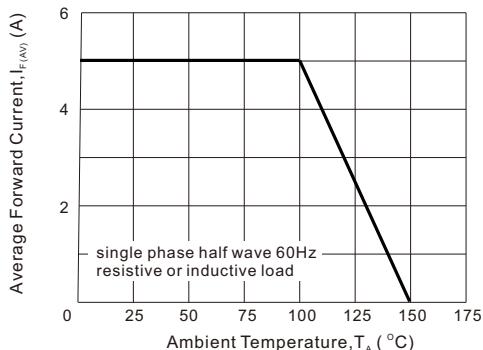


Fig.2 :Instantaneous Forward Voltage

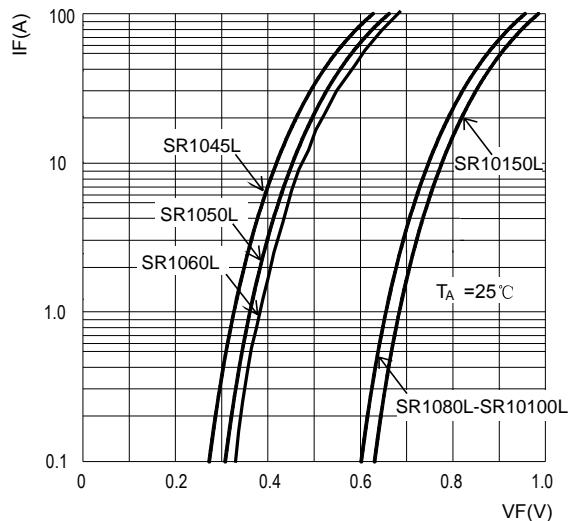


Fig.3: Surge Forward Current Capability

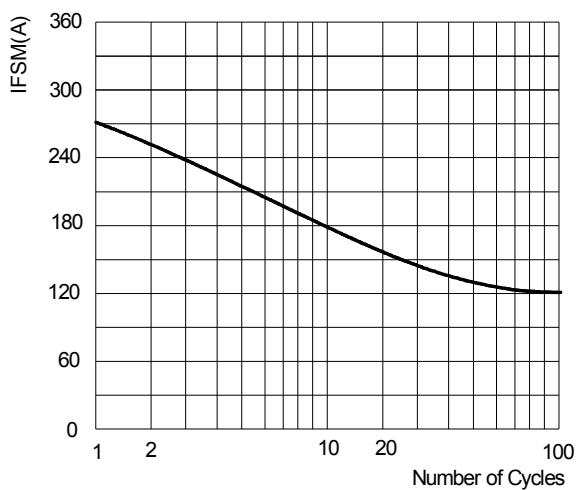


Fig.4: Typical Reverse Characteristics

